



Solid State Relay  
OCMOS FET

# PS7341-1A, PS7341L-1A

6-PIN DIP, HIGH ISOLATION VOLTAGE  
400 V BREAK DOWN VOLTAGE  
NORMALLY OPEN TYPE  
1-ch Optical Coupled MOS FET

–NEPOC Series–

## DESCRIPTION

The PS7341-1A and PS7341L-1A are solid state relays containing GaAs LEDs on the light emitting side (input side) and MOS FETs on the output side.

They are suitable for analog signal control because of their low offset and high linearity.

The PS7341L-1A has a surface mount type lead.

## FEATURES

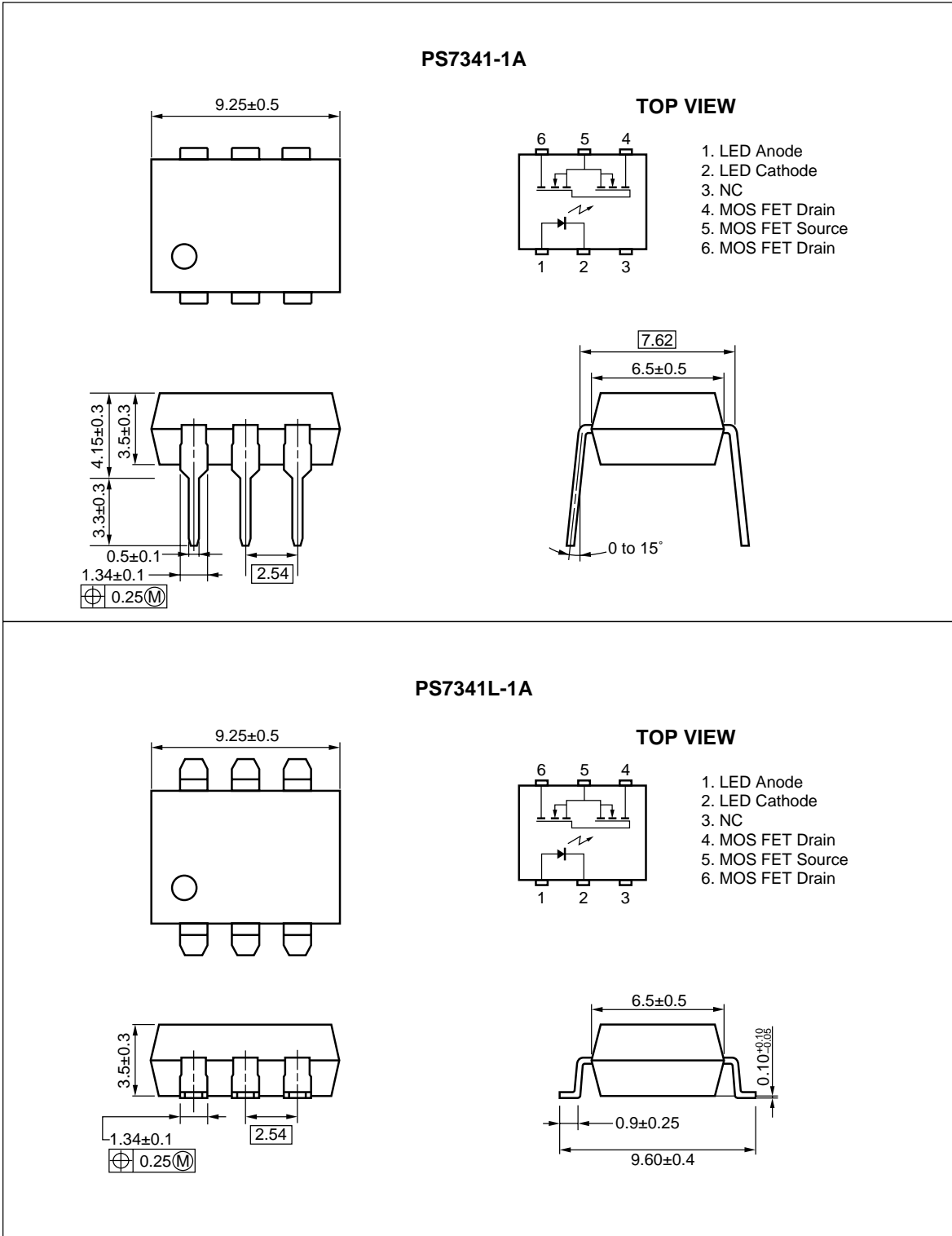
- High isolation voltage (BV = 3 750 Vr.m.s.)
- 1 channel type (1 a output)
- Low LED Operating Current ( $I_F = 2$  mA)
- Designed for AC/DC switching line changer
- Small package (6-pin DIP)
- Low offset voltage
- Ordering number of taping product : PS7341L-1A-E3, E4: 1 000 pcs/reel
- <R> • Pb-Free product
- <R> • Safety standards
  - UL approved: File No. E72422
  - BSI approved: No. 8252/8253
  - CSA approved: No. CA 101391
  - SEMKO approved: No. 606398
  - DEMKO approved: No. 309836
  - NEMKO approved: No. P00100964
  - FIMKO approved: No. FI 15188
  - DIN EN60747-5-2 (VDE0884 Part2) approved (Option)

## APPLICATIONS

- Exchange equipment
- Measurement equipment
- FA/OA equipment

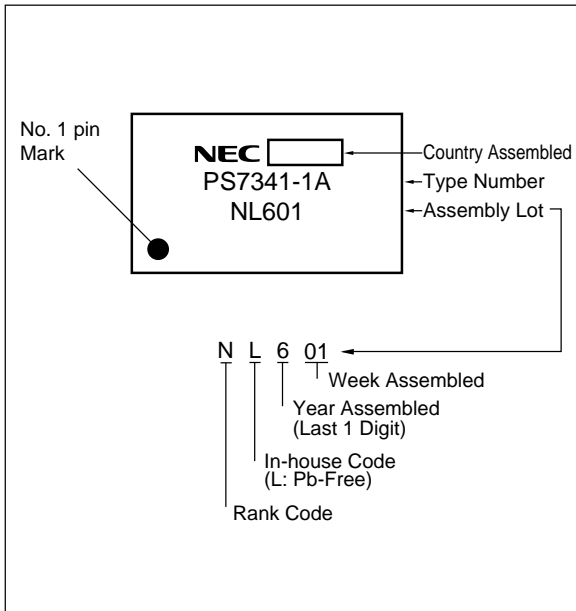
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PACKAGE DIMENSIONS (in millimeters)



### PS7341L-1A

<R> MARKING EXAMPLE



<R> **ORDERING INFORMATION**

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number*1
PS7341-1A	PS7341-1A-A	Pb-Free	Magazine case 50 pcs	Standard products	PS7341-1A
PS7341L-1A	PS7341L-1A-A			(UL, BSI, CSA, SEMKO,	
PS7341L-1A-E3	PS7341L-1A-E3-A		Embossed Tape 1 000 pcs/reel	DEMKO, NEMKO,	
PS7341L-1A-E4	PS7341L-1A-E4-A			FIMKO approved)	

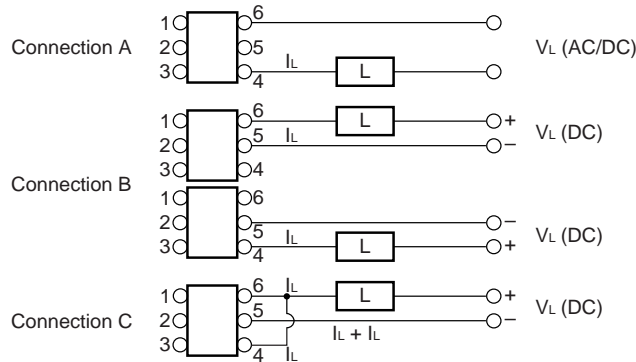
\*1 For the application of the Safety Standard, following part number should be used.

**ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C, unless otherwise specified)**

Parameter		Symbol	Ratings	Unit	
Diode	Forward Current (DC)	I <sub>F</sub>	50	mA	
	Reverse Voltage	V <sub>R</sub>	5.0	V	
	Power Dissipation	P <sub>D</sub>	50	mW	
	Peak Forward Current <sup>*1</sup>	I <sub>FP</sub>	1	A	
MOS FET	Break Down Voltage	V <sub>L</sub>	400	V	
	Continuous Load Current <sup>*2</sup>	Connection A	I <sub>L</sub>	150	mA
		Connection B		200	
		Connection C		300	
	Pulse Load Current <sup>*3</sup> (AC/DC Connection)	I <sub>LP</sub>	300	mA	
Power Dissipation	P <sub>D</sub>	560	mW		
Isolation Voltage <sup>*4</sup>		BV	3 750	Vr.m.s.	
Total Power Dissipation		P <sub>T</sub>	610	mW	
Operating Ambient Temperature		T <sub>A</sub>	-40 to +85	°C	
Storage Temperature		T <sub>stg</sub>	-40 to +125	°C	

\*1 PW = 100 μs, Duty Cycle = 1%

\*2 Conditions: I<sub>F</sub> ≥ 2 mA. The following types of load connections are available.



\*3 PW = 100 ms, 1 shot

\*4 AC voltage for 1 minute at T<sub>A</sub> = 25°C, RH = 60% between input and output  
Pins 1-3 shorted together, 4-6 shorted together.

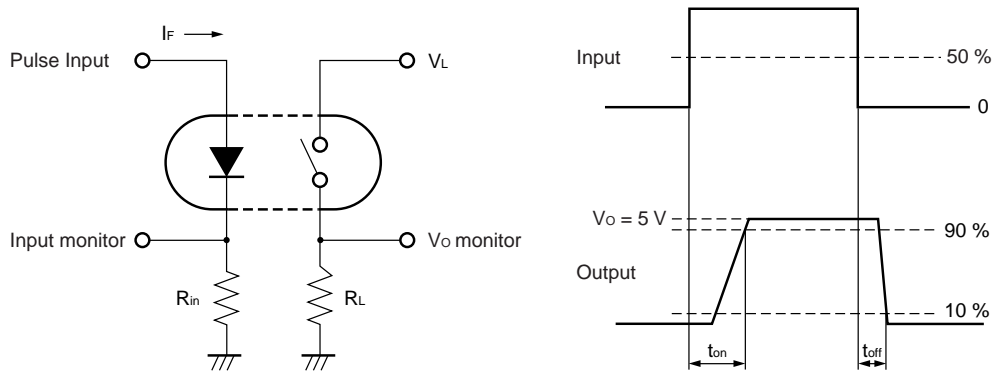
**RECOMMENDED OPERATING CONDITIONS (TA = 25°C)**

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	IF	2	10	20	mA
LED Off Voltage	VF	0		0.5	V

**ELECTRICAL CHARACTERISTICS (TA = 25°C)**

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA		1.2	1.4	V
	Reverse Current	IR	VR = 5 V			5.0	μA
MOS FET	Off-state Leakage Current	I <sub>off</sub>	VD = 400 V		0.03	1.0	μA
	Output Capacitance	C <sub>out</sub>	VD = 0 V, f = 1 MHz		65		pF
Coupled	LED On-state Current	I <sub>Fon</sub>	IL = 150 mA			2.0	mA
	On-state Resistance	R <sub>on1</sub>	IF = 10 mA, IL = 10 mA		20	30	Ω
		R <sub>on2</sub>	IF = 10 mA, IL = 150 mA, t ≤ 10 ms		16	25	
	Turn-on Time <sup>*1,2</sup>	t <sub>on</sub>	IF = 10 mA, VO = 5 V, RL = 2 kΩ,		0.35	1.0	ms
	Turn-off Time <sup>*1,2</sup>	t <sub>off</sub>	PW ≥ 10 ms		0.03	0.2	
	Isolation Resistance	RI-O	VI-O = 1.0 kV <sub>DC</sub>		10 <sup>9</sup>		Ω
Isolation Capacitance	CI-O	V = 0 V, f = 1 MHz			1.1	pF	

**\*1 Test Circuit for Switching Time**

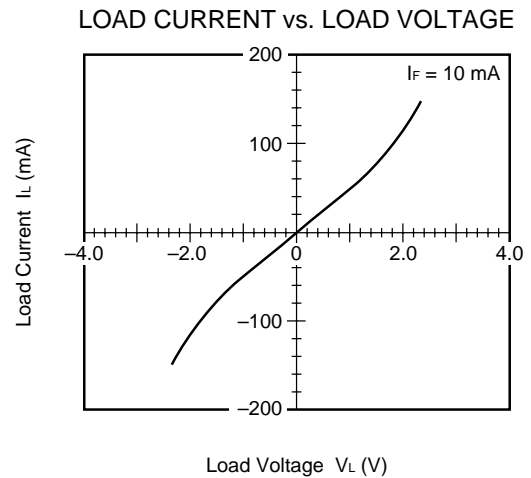
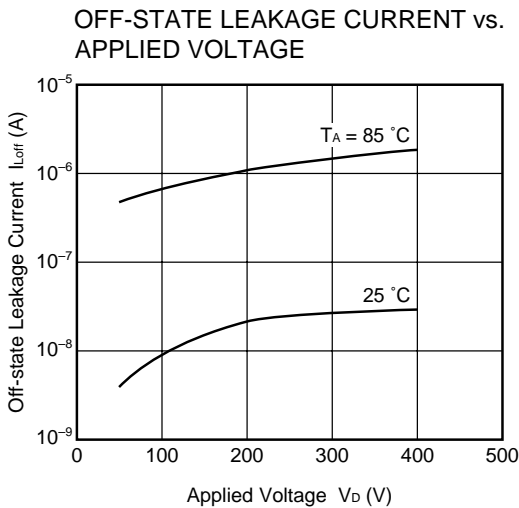
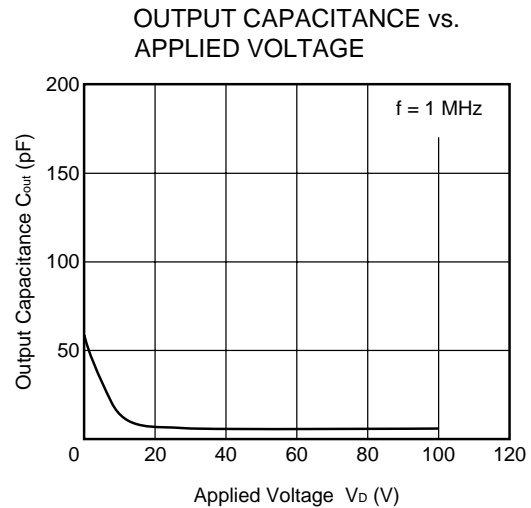
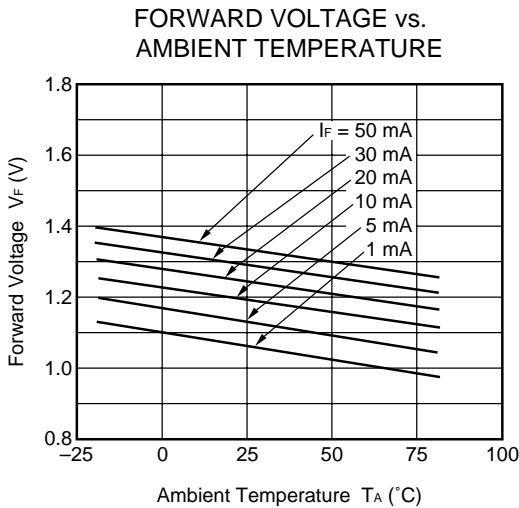
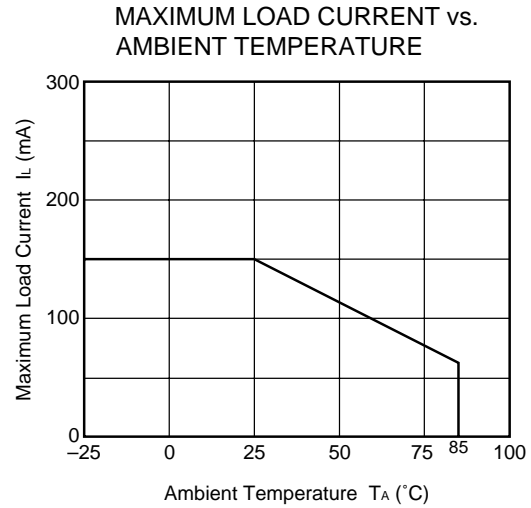
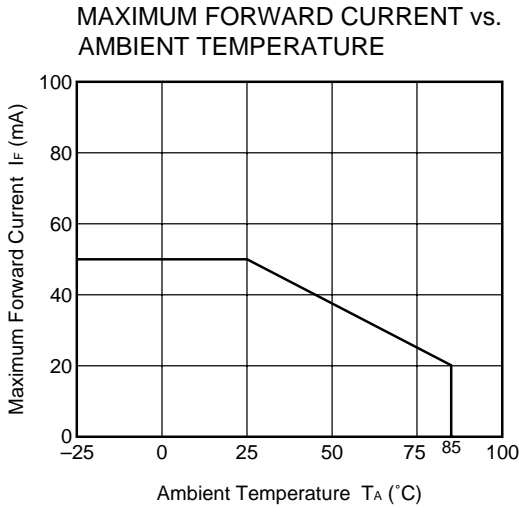


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**\*2** The turn-on time and turn-off time are specified as input-pulse width ≥ 10 ms.

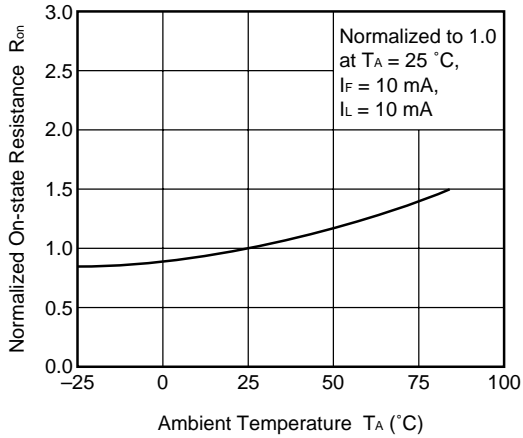
Be aware that when the device operates with an input-pulse width less than 10 ms, the turn-on time and turn-off time will increase.

**TYPICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ , unless otherwise specified)**

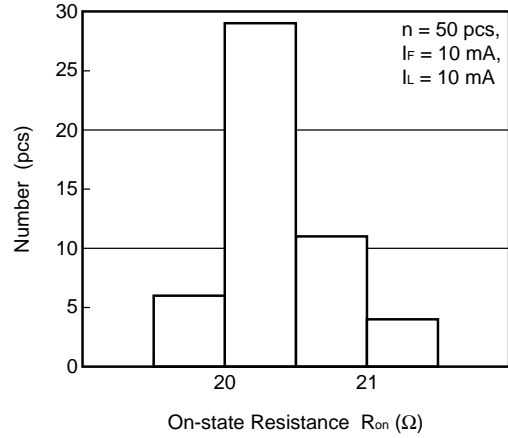


**Remark** The graphs indicate nominal characteristics.

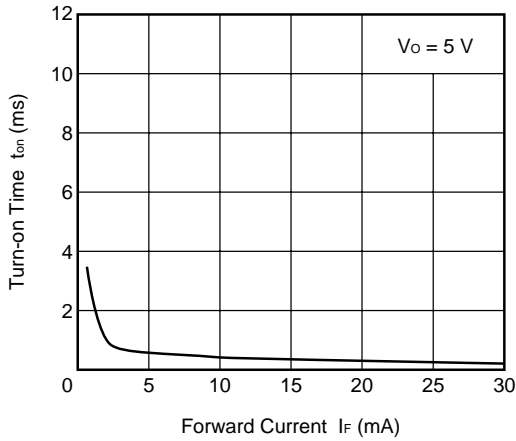
NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



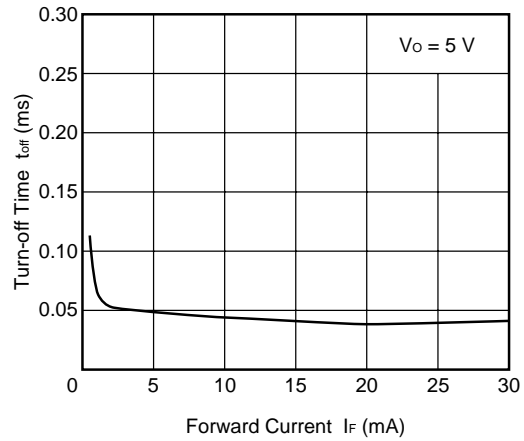
ON-STATE RESISTANCE DISTRIBUTION



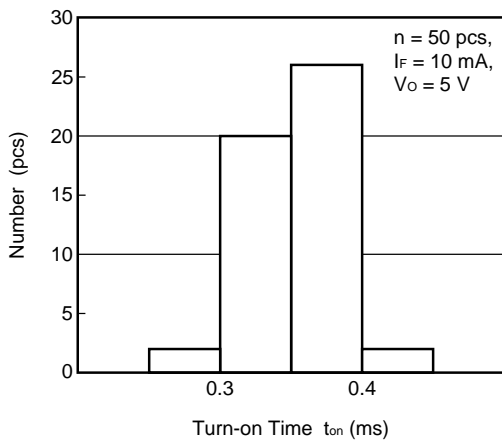
TURN-ON TIME vs. FORWARD CURRENT



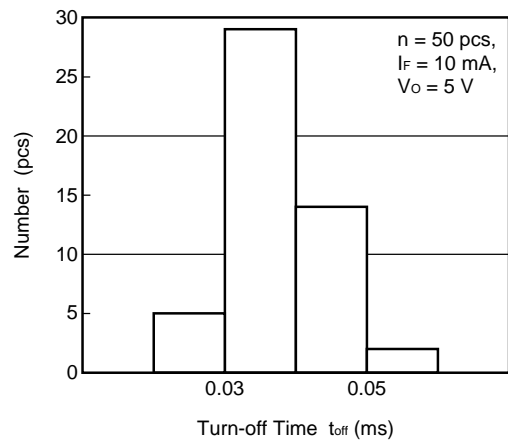
TURN-OFF TIME vs. FORWARD CURRENT



TURN-ON TIME DISTRIBUTION

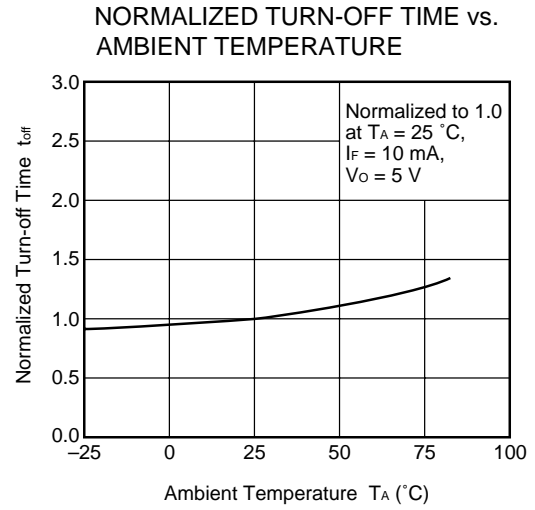
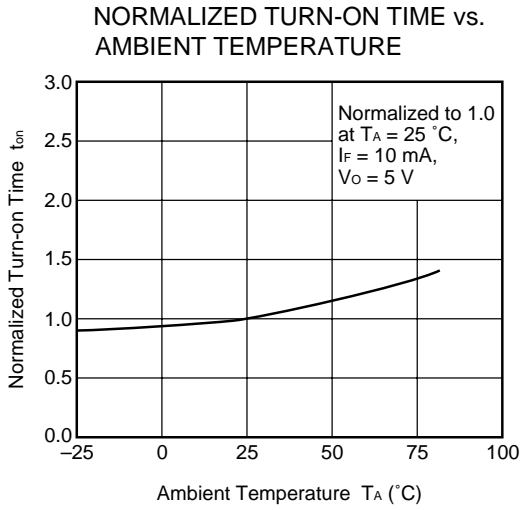


TURN-OFF TIME DISTRIBUTION



**Remark** The graphs indicate nominal characteristics.

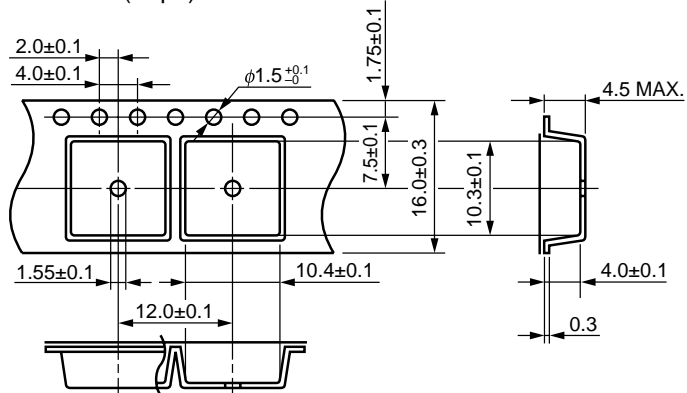




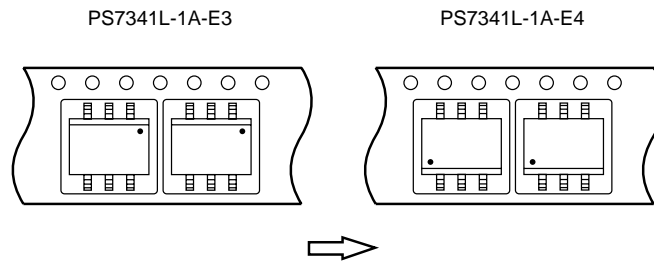
**Remark** The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS (in millimeters)

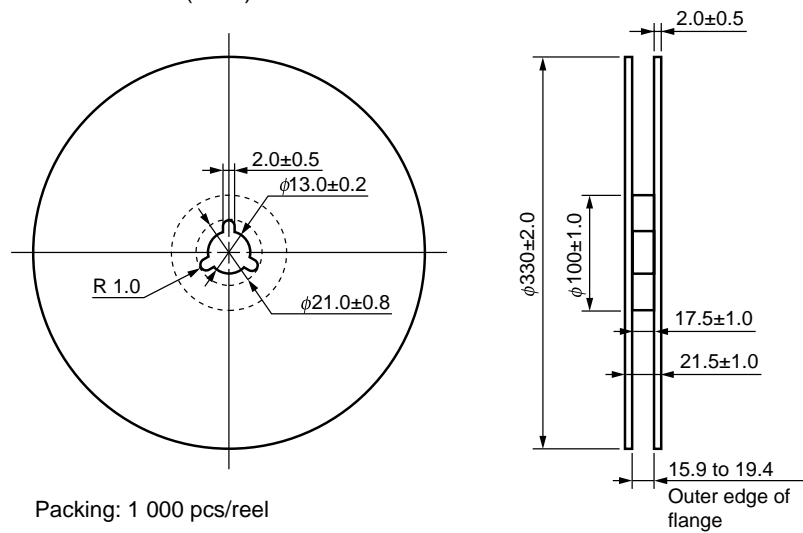
Outline and Dimensions (Tape)



Tape Direction



Outline and Dimensions (Reel)

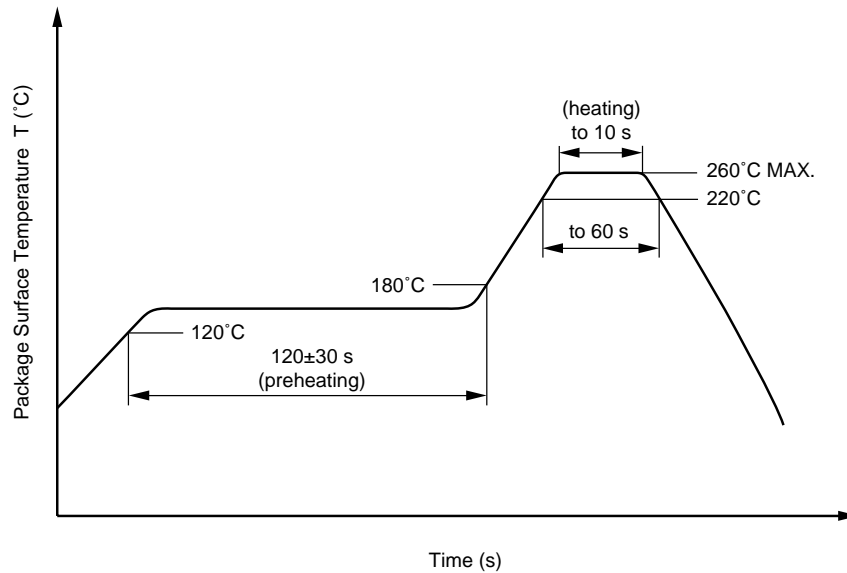


**RECOMMENDED SOLDERING CONDITIONS**

**(1) Infrared reflow soldering**

- Peak reflow temperature 260°C or below (package surface temperature)
- Time of peak reflow temperature 10 seconds or less
- Time of temperature higher than 220°C 60 seconds or less
- Time to preheat temperature from 120 to 180°C 120±30 s
- Number of reflows Two
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



**(2) Wave soldering**

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

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**(3) Soldering by soldering iron**

- Peak temperature (lead part temperature) 350°C or below
- Time (each pins) 3 seconds or less
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.
- (b) Please be sure that the temperature of the package would not be heated over 100°C.

**(4) Cautions**

- <R>
- To avoid quality degradation, assembling within 1 month after take this device out from covered pack is required.  
(Storage conditions 25°C, 65%RH MAX.)
  - Fluxes  
    Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

<R> **USAGE CAUTIONS**

1. Protect against static electricity when handling.
2. Avoid storage at a high temperature and high humidity.

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M8E 02.11-1

<b>Caution</b>	GaAs Products	<p>This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.</p> <ul style="list-style-type: none"><li>• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.</li></ul> <ol style="list-style-type: none"><li>1. Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.</li><li>2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.</li></ol> <ul style="list-style-type: none"><li>• Do not burn, destroy, cut, crush, or chemically dissolve the product.</li><li>• Do not lick the product or in any way allow it to enter the mouth.</li></ul>
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► For further information, please contact

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